

Title (en)

SCR-ACTIVE MATERIAL HAVING ENHANCED THERMAL STABILITY

Title (de)

SCR-AKTIVES MATERIAL MIT ERHÖHTER THERMISCHER STABILITÄT

Title (fr)

MATÉRIAUX ACTIFS SCR PRÉSENTANT UNE STABILITÉ THERMIQUE ÉLEVÉE

Publication

**EP 3496854 A1 20190619 (DE)**

Application

**EP 17758823 A 20170811**

Priority

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Abstract (en)

[origin: WO2018029329A1] The invention relates to an SCR-active material, comprising a small-pored zeolite of the structure type levyne (LEV), aluminum oxide, and copper, characterized in that based on the total material, the material contains 4 to 25 wt% of aluminum oxide.

IPC 8 full level

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See references of WO 2018029329A1

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